

United States Patent and Trademark Office

UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Virginia 22313-1450 www.uspto.gov

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
10/667,139	09/17/2003	Norbert Ebel	948-001.002	7192
4955 7.	590 12/01/2006		EXAMINER	
WARE FRESSOLA VAN DER SLUYS &			CHIEM, DINH D	
ADOLPHSON BRADFORD (, LLP GREEN, BUILDING 5		ART UNIT	PAPER NUMBER
755 MAIN STREET, P O BOX 224			2883	
MONROE, CT 06468			DATE MAILED: 12/01/2006	

Please find below and/or attached an Office communication concerning this application or proceeding.

·			4 //
	Application No.	Applicant(s)	
	10/667,139	EBEL, NORBERT	
Office Action Summary	Examiner	Art Unit	
	Erin D. Chiem	2883	
The MAILING DATE of this communication app Period for Reply	ears on the cover sheet with the c	orrespondence add	ess
A SHORTENED STATUTORY PERIOD FOR REPLY WHICHEVER IS LONGER, FROM THE MAILING DA - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	ATE OF THIS COMMUNICATION 36(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from a cause the application to become ABANDONE	N. nely filed the mailing date of this corr D (35 U.S.C. § 133).	
Status			
1) Responsive to communication(s) filed on 21 Acceptable 2a) This action is FINAL. 2b) This 3) Since this application is in condition for allower closed in accordance with the practice under Expression in the practice of the condition of the c	action is non-final. nce except for formal matters, pro		merits is
Disposition of Claims			
4) ☐ Claim(s) 1-20 is/are pending in the application. 4a) Of the above claim(s) 8,9 and 15 is/are with 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-7,10-14 and 16-20 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/o	ndrawn from consideration.		
Application Papers			
9) The specification is objected to by the Examine 10) The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the Example.	epted or b) objected to by the identified or b) objected to by the identified or by the ident	e 37 CFR 1.85(a). jected to. See 37 CFF	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priori	s have been received. s have been received in Applicati rity documents have been receive u (PCT Rule 17.2(a)).	on No ed in this National S	tage
Attachment(s) Notice of References Cited (PTO-892) Notice of Draftsperson's Patent Drawing Review (PTO-948) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:	ate	

DETAILED ACTION

Page 2

This office action is in response to applicant's amendment filed on August 21, 2006.

Currently, claims 1-20 are pending.

Claim Objections

In view of the amendment and remarks, the claim objections made in office action (mailed date May 22, 2006) are withdrawn.

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-7, and 16-20 are rejected under 35 U.S.C. 103(a) as being unpatentable over Althaus et al. (US 6,422,766 B1 hereinafter "Althaus") in view of Kluitmans et al. (US 5,065,226 hereinafter "Kluitmans") and Amano et al. (US 6,222,967 B1 "Amano" hereinafter).

Regarding claims 1, 2, 7, 14, and 17 Althaus teaches a device for sending or receiving optical signals wherein an opto-electrical transducer (laser chip 12), together with an associated glass fiber (23) are arranged on a common support characterized in that

The support is a circuit board (227'); see Fig. 12 comprising different multiple layers of insulating material (col. 4, lines 29-30) and intermediate layers of metal (conductor tracks), with a recess (visible as white open space in Fig. 13) formed therein containing

an opening covered by a lid (329), wherein the lid is made of metal (col. 8, line 15-16), and a bottom on which conductor tracks, configured as microstrips, on the RF conductor track carrier (327B) (col. 12, lines 37-40).

- The transducer (12) is entirely located in the recess and is connected to the conducting tracks,
- The glass fiber exits from the recess through an opening in the circuit board, and
- An electrically active shield is installed around the circuit board (250).

Regarding claim 16, a Peltier element (211) is located on the bottom of the recess on which heats up the conductor track carrier.

However, Althaus does not explicitly teach that the conductor tracks are impedance-matched as recited in claims 1, 2, and 7. Furthermore, Althaus does not explicitly teach the recess being formed integrally with the substrate.

Kluitmans teaches a laser diode module that comprises of microstrips formed on the bottom of the module (Fig. 3; GT₁ and GT₂) that are coupled to a coaxial transmission line at matching impedance (col. 9, lines 35-39) for the purpose of maximizing power transfer from one electrical component to another.

Amano discloses a packaging platform for an optical module that uses injection molding or transfer molding techniques (col. 4, line 25-27) for the purpose of simplifying manufacturing steps.

Since Althaus, Kluitmans and Amano are both from the same field of endeavor, the purpose disclosed by Kluitmans and Amano would have been recognized in the pertinent art of Althaus.

Page 4

The motivation for impedance matching is for to maximize transfer of power between two or more electronic components. It would have been obvious at the time the invention was made to a person having ordinary skill in the art to match the impedance by providing a high voltage conductor with a large resistor and a low voltage conductor with a low resistor. Furthermore, as clearly shown by Althaus and Kluitmans that a recess is used to house the optoelectronic components as well as the ferrule for coupling the transducer with an optical fiber. It would have been obvious at the time the invention was made to a person having ordinary skill in the art to form the recess integrally as disclosed by Amano by injection molding or transfer molding. The motivation for integrally form the recess is to reduce manufacturing labor; thus reducing manufacturing cost.

Regarding claims 3-4, all three references disclose providing a metal plate as a cover Althaus (col. 1, line 25), Kluitmans (col. 5, line 25), Amano (col. 23, line 49).

Regarding claims 5, 6 and 12, Althaus discloses at least some of the conducting tracks protrude laterally from the recess (col. 12, lines 40-41) to the surrounding edge areas of the circuit board (shown in Fig. 11B as the small rectangles on the peripheral) that extend to a common surface on the inside of the circuit board where they respectively end on a contact surface,

Regarding claims 7, 18 and 19, Kluitmans further describe the extension of the microstrips through the coaxial transmission line to the external module (col. 9, lines 59-62). In order for the connection to be in a reflection-free manner, the inside diameter of the feedthrough is chosen such that the characteristic impedance of a coaxial transmission line is equal to that of the external microstrip. Furthermore, the ratio between the inside diameter of the outer guide of the coaxial transmission line and the outside diameter of the inner guide, with a given dielectric constant of the medium between the guides, the characteristic impedance of the coaxial transmission line can be matched to that of the microstrip line (col. 9, lines 33-49). Furthermore, in Fig. 5, the elements are positioned on the conducting tracks in a relatively planar configuration. The motivation for using microstrips through coaxial transmission line to connector to the laser diode is to reduce the influence of the inductance of guide pin on the matching of the laser diode module to the characteristic impedance of the external transmission; thus improving power transfer between the microstrips and the laser diode.

Regarding claims 16 and 20 Kluitmans discloses that it is known in various application to provide a thermal contact surface below the laser diode such that the thermal contact surface thermoconductively contact to the base surface and lead the heat away from the laser diode (Col. 3, line 15-25). The motivation for providing a thermal contact surface to lead heat away from the laser diode is to prevent the optical module from over heating and wherein the module may contain elements that will break down due to the high thermal energy produced by the laser diode.

Response to Arguments

Applicant traversed the rejection above for the reason of no motivation to combine the reference of Althaus (US 6,422,766 B1), Kluitmans (US 5,065,226), and Amano (US 6,222,967 B1) because applicant believes citation of Amano column 4, lines 25-27 states the package manufacturing process by a mold or injection molding does not overcome the claimed limitation of integral recess as represented by claim 1. However, claim 1 as exemplified by Fig. 1

Art Unit: 2883

illustrates a recess, the combination of injection molding disclosed in Fig. 18b of Amano reference would make clear to one having ordinary skill in the art to use this process to form a integral recess of the same material as the claimed substrate that houses the optical components. Therefore, the ground of rejection is maintained.

Conclusion

THIS ACTION IS MADE FINAL. Applicant is reminded of the extension of time policy as set forth in 37 CFR 1.136(a).

A shortened statutory period for reply to this final action is set to expire THREE MONTHS from the mailing date of this action. In the event a first reply is filed within TWO MONTHS of the mailing date of this final action and the advisory action is not mailed until after the end of the THREE-MONTH shortened statutory period, then the shortened statutory period will expire on the date the advisory action is mailed, and any extension fee pursuant to 37 CFR 1.136(a) will be calculated from the mailing date of the advisory action. In no event, however, will the statutory period for reply expire later than SIX MONTHS from the mailing date of this final action.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Erin D. Chiem whose telephone number is (571) 272-3102. The examiner can normally be reached on Monday - Thursday 9AM - 5PM.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Frank G. Font can be reached on (571) 272-2415. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Application/Control Number: 10/667,139

Art Unit: 2883

Page 7

Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR

Information regarding the status of an application may be obtained from the Patent

system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would

like assistance from a USPTO Customer Service Representative or access to the automated

information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

Erin D Chiem Examiner Art Unit 2883

Frank G. Font
Supervisory Patent Examiner
Technology Code 0900

Fand State